

NOT RECOMMENDED FOR NEW DESIGN **USE PDS540**

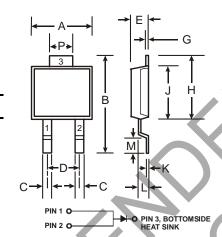
5A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER POWERMITE®3

Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Lead Free Finish, RoHS Compliant (Note 2)

Mechanical Data

- Case: POWERMITE®3
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish).
- Polarity: See Diagram
- Marking Information: See Page 3 Ordering Information: See Page 3
- Weight: 0.072 grams (approximate)



Dim Min Max 4.03 4.09 Α В 6.40 6.61 C .889 NOM D 1.83 NOM Ε 1.10 1.14 G .178 NOM Н 5.01 5.17 J 4.37 4.43 K .178 NOM .71 .77 .36 M .46 1.83 1.73 All Dimensions in mm

POWERMITE®3

Note:

Pins 1 & 2 must be electrically Pins 1 & 2 must be electrically connected at the printed circuit board.

Maximum Ratings @T_A = 25℃ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40	V
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Rectified Output Current (see also Figure 5)	lo	5	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load @ $T_C = 90^{\circ}$ C	IFSM	100	А
Typical Thermal Resistance Junction to Soldering Point	$R_{ hetaJS}$	3.2	°C/W
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	C

Electrical Characteristics @TA = 25°C unless otherwise specified

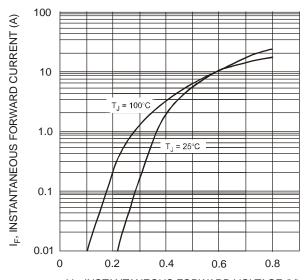
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	V _{(BR)R}	40	_	_	٧	$I_R = 0.5 \text{mA}$
		_	0.48	0.52	V	$I_F = 5A, T_S = 25^{\circ}C$
Forward Voltage	V _{FM}	_	0.45	_		I _F = 5A, T _S = 125°C
	VEM	_	0.59	_		I _F = 10A, T _S = 25°C
		_	0.56	_		I _F = 10A, T _S = 125°C
Reverse Current (Note 1)		_	0.05	0.5		$T_S = 25^{\circ}C, V_R = 40V$
Reverse Current (Note 1)	I _{RM}	_	2.5	20		$T_S = 100^{\circ}C, V_R = 40V$
Total Capacitance	Ст		250	_	pF	$f = 1.0MHz, V_R = 4.0V DC$

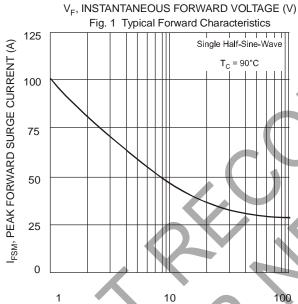
Notes:

- 1. Short duration pulse test used to minimize self-heating effect.
- 2. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.

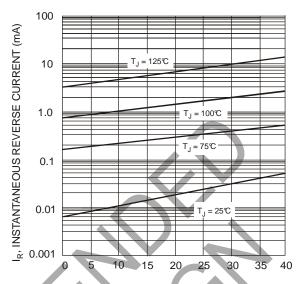


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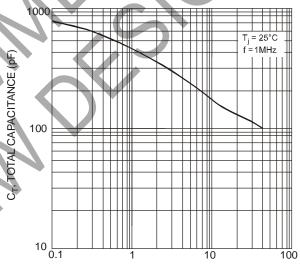




NUMBER OF CYCLES AT 60 Hz Fig. 3 Max Non-Repetitive Peak Forward Surge Current



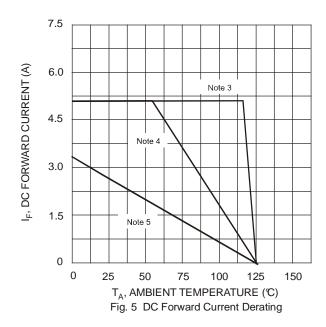
V_R, INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 2 Typical Reverse Characteristics

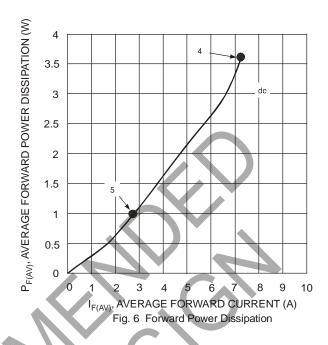


V_R, REVERSE VOLTAGE (V) Fig. 4 Typical Total Capacitance vs. Reverse Voltage



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Notes:

- 3. $T_A = T_{SOLDERING\ POINT},\ R_{\theta JS} = 3.2 \text{C/W},\ R_{\theta SA} = 0 \text{C/W}.$
- 4. Device mounted on GETEK substrate, 2"x 2", 2 oz. copper, double-sided, cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". R_{0JA} in range of 15-30℃/W.
- 5. Device mounted on FR-4 substrate, 2"x 2", 2 oz. copper, single-sided, pad layout as per Diodes Inc. suggested pad layout document AP02001 which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. R_{BJA} in range of 60-75 °C/W.

Ordering Information (Note 6)

Device	Packaging	Shipping
SBM540-13-F	POWERMITE®3	5000/Tape & Reel

6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



SBM540 = Product type marking code ⊃¦¦ = Manufacturers' code marking YYWW = Date code marking YY = Last digit of year (ex: 02 for 2002) WW = Week code (01 to 53) (K) = Factory Designator



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